

ABSTRACT OF THE DISCLOSURE

A resin composition prepared by melt-mixing (A) a hydrolyzed ethylene-vinyl acetate copolymer having a water content of 20 to 50 % by weight and (B) a water-swellable inorganic compound having a layer structure in an extruder under the condition of $200 < R \times W < 8,000$ wherein R is a residence time (second) of (A) and (B) in the extruder from the introduction of both (A) and (B) into the extruder up to the extrusion thereof from the extruder, and W is a consumed electric power (kW) of the extruder. The composition provides molded articles such as film having excellent boiling water resistance, impact resistance and flex cracking resistance as well as gas barrier property, which are useful as a packaging material